Hittite MICROWAVE CORPORATION v01.0310

RoHS EARTH FRIENDLY

HMC890LP5E

FILTER - TUNABLE, BAND PASS SMT 1 - 2 GHz

Typical Applications

The HMC890LP5E is ideal for:

- Test & Measurement Equipment
- Military RADAR & EW/ECM
- SATCOM & Space
- Industrial & Medical Equipment

Features

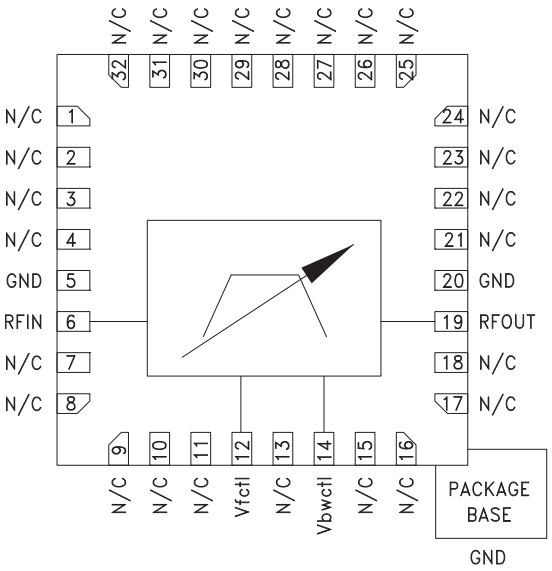
Fast Tuning Response; 200 ns

Excellent Wideband Rejection; 30 dB

Single Chip Replacement for Mechanically Tuned Designs

32 Lead 5x5 mm SMT Package

Functional Diagram



General Description

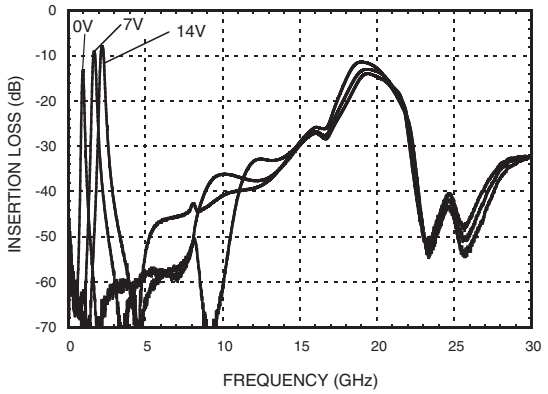
The HMC890LP5E is a MMIC band pass filter which features a user selectable passband frequency. The 3 dB filter bandwidth is approximately 11%. The 20 dB filter bandwidth is approximately 33%. The center frequency can be varied between 1 and 2 GHz by applying an analog tune voltage between 0 and 14V. This tunable filter can be used as a much smaller alternative to physically large switched filter banks and cavity tuned filters. The HMC890LP5E has excellent microphonics due to the monolithic design, and provides a dynamically adjustable solution in advanced communications applications.

Electrical Specifications, T_A = +25°C, V_{fctl} = V_{bwctl} Unless Otherwise Stated

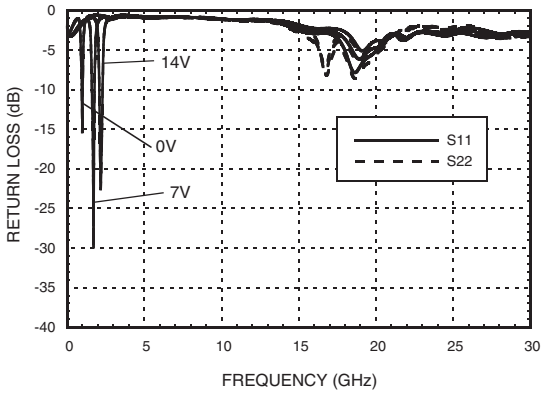
Parameter	Min.	Typ.	Max.	Units
F_{center} Tuning Range	1		2	GHz
3 dB Bandwidth		11		%
Low Side Rejection Frequency (Rejection >20 dB)		0.86*F_{center}		GHz
High Side Rejection Frequency (Rejection >20 dB)		1.19*F_{center}		GHz
Re-entry Frequency (Rejection <30 dB)		9		GHz
3 dB Bandwidth Control (V_{bwctl})		±3		%
Insertion Loss		9		dB
Return Loss		10		dB
Maximum Input Power for Linear Operation			10	dBm
Frequency Control Voltage (V_{fctl})	0		14	V
Source/Sink Current (I_{fctl})			±1	mA
Bandwidth Control Voltage (V_{bwctl})	0		14	V
Source/Sink Current (I_{bwctl})			±1	mA
Residual Phase Noise [1] (1 MHz Offset)		-155		dBc/Hz
F_{center} Drift Rate		-0.3		MHz/°C
Tuning Characteristics [2] tFULLBAND (0% Vfctl to 90% RF)		200		ns

[1] Optimum residual phase noise performance requires the use of a low noise driver circuit.
[2] Tuning speed is dependent on driver circuit. Data measured with a high speed op-amp driver and includes driver slew rate delay.

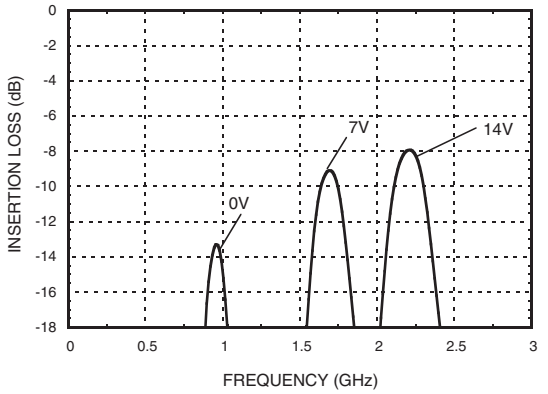
Broadband Insertion Loss vs. Control Voltages, Vfctl = Vbwctl



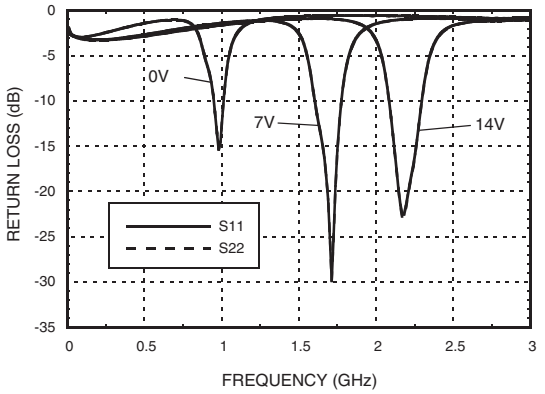
Broadband Return Loss vs. Control Voltages, Vfctl = Vbwctl



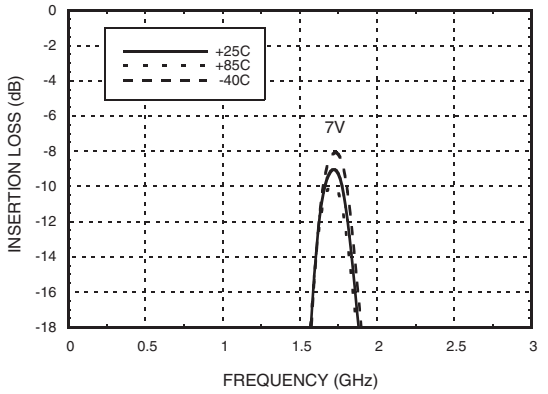
Insertion Loss vs. Control Voltages, Vfctl = Vbwctl



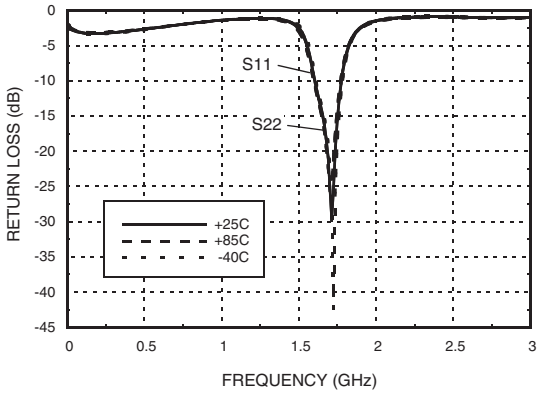
Return Loss vs. Control Voltages, Vfctl = Vbwctl



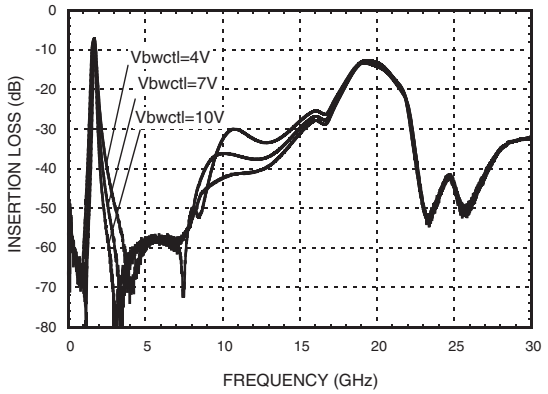
Insertion Loss vs. Temperature, Vfctl = Vbwctl = 7V



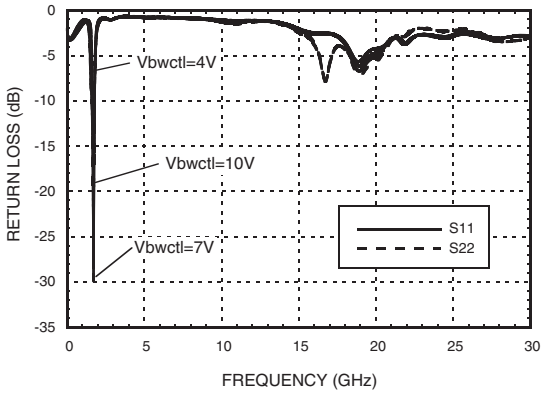
Return Loss vs. Temperature, Vfctl = Vbwctl = 7V



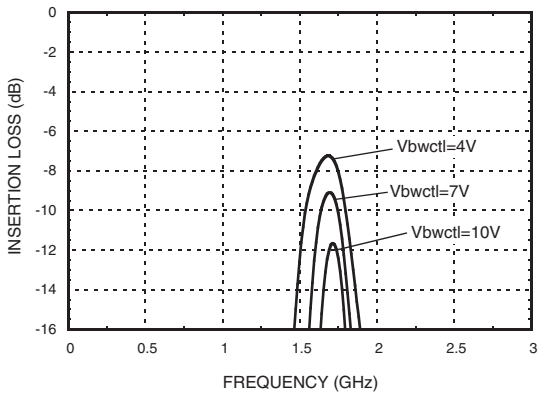
Broadband Insertion Loss vs. Vbwctl, Vfctl = 7V



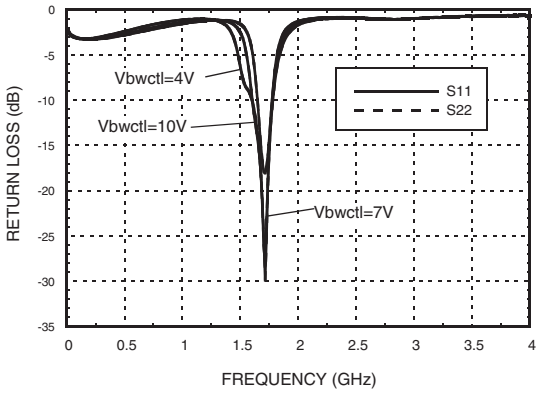
Broadband Return Loss vs. Vbwctl, Vfctl = 7V



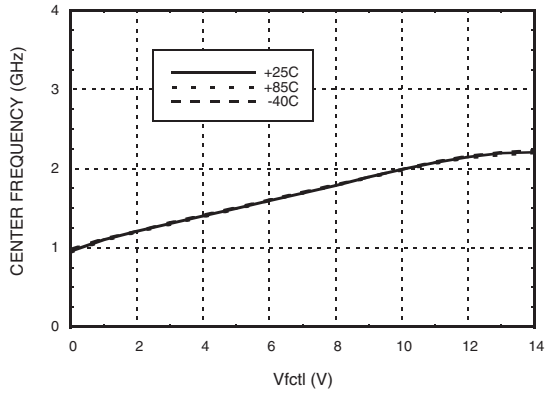
Insertion Loss vs. Vbwctl, Vfctl = 7V



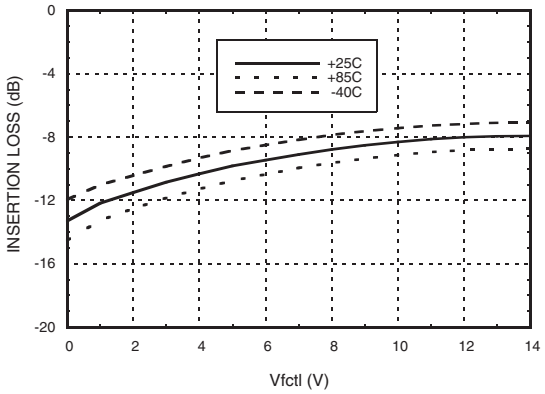
Return Loss vs. Vbwctl, Vfctl = 7V



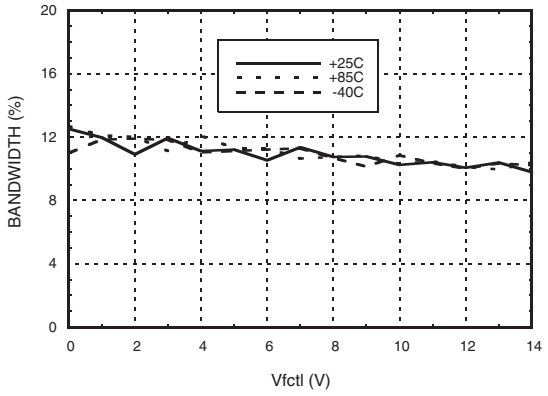
Center Frequency vs. Temperature, Vfctl = Vbwctl



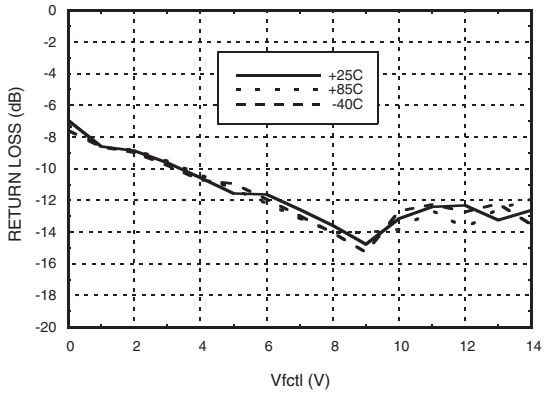
Insertion Loss vs. Temperature, Vfctl = Vbwctl



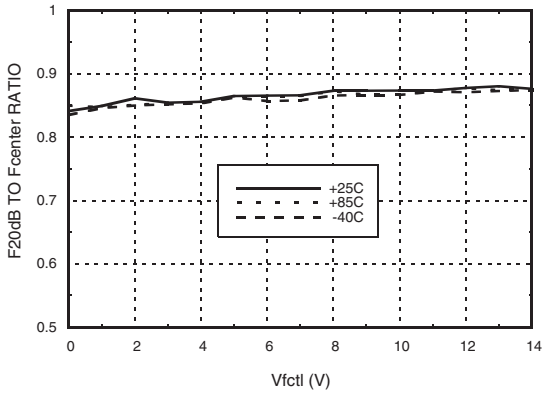
3 dB Bandwidth vs. Temperature, Vfctl = Vbwctl



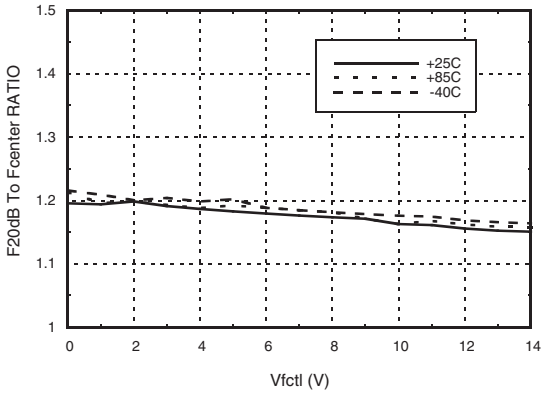
Maximum Return Loss in a 2 dB Bandwidth vs. Temperature, Vfctl = Vbwctl



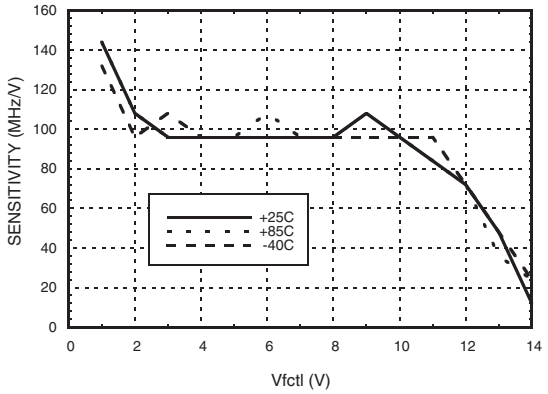
Low Side Rejection Ratio vs. Temperature, Vfctl = Vbwctl [1]



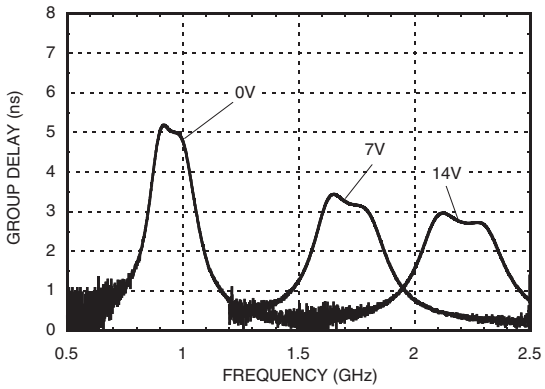
High Side Rejection Ratio vs. Temperature, Vfctl = Vbwctl [1]



Tuning Sensitivity vs. Temperature, Vfctl = Vbwctl



Group Delay



[1] Rejection ratio is defined as the ratio of the frequency at which the relative insertion loss is 20 dB to *f*center

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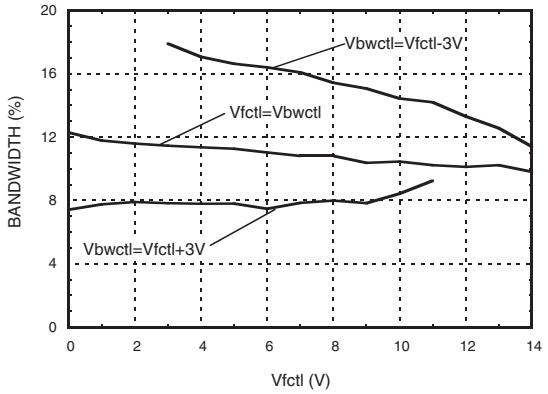
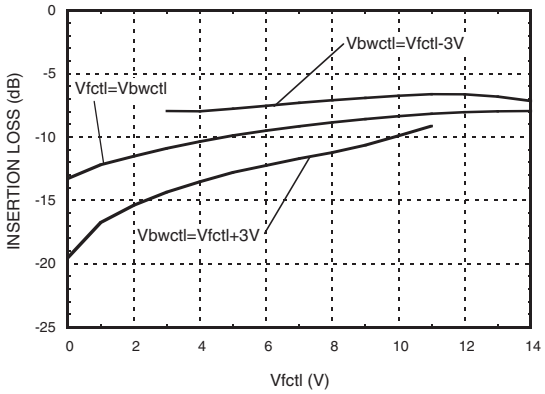
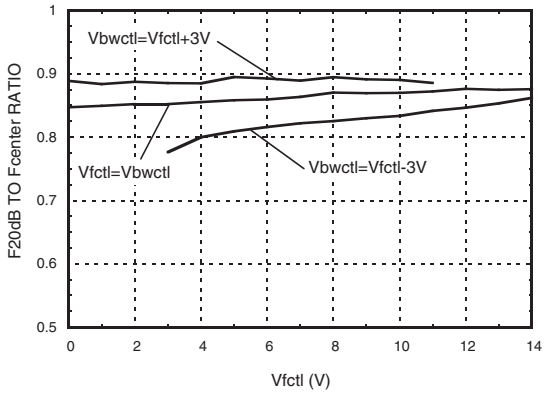
3 dB Bandwidth vs. Bandwidth Control



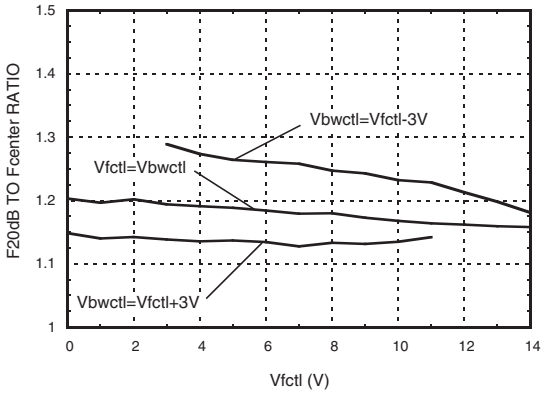
Insertion Loss vs. Bandwidth Control



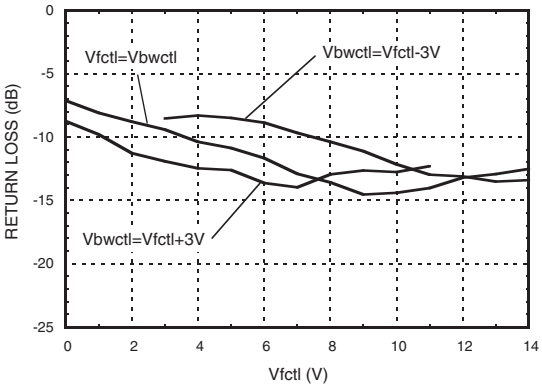
Low Side Rejection Ratio vs. Bandwidth Control [1]



High Side Rejection Ratio vs. Bandwidth Control [1]



Maximum Return Loss in a 2 dB Bandwidth vs. Bandwidth Control



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FILTER - TUNABLE, BAND PASS SMT 1 - 2 GHz

Absolute Maximum Ratings

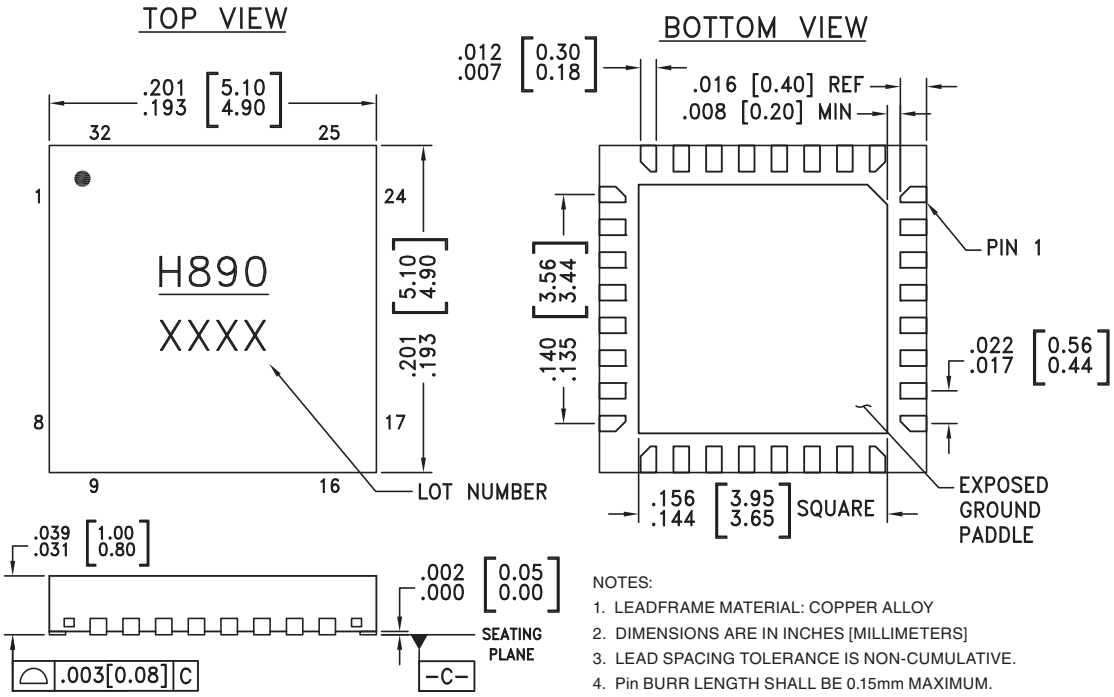
Frequency Control Voltage (Vfctl)	-0.5 to +15V
Bandwidth Control Voltage (Vbwctl)	-0.5 to +15V
RF Power Input	27 dBm
Storage Temperature	-65 to +150 °C
ESD Rating (HBM)	Class 1B

ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Reliability Information

Junction Temperature to Maintain 1 Million Hour MTTF	150 °C
Nominal Junction Temperature (T= 85 °C and Pin = 10 dBm)	90 °C
Operating Temperature	-40 to +85 °C

Outline Drawing



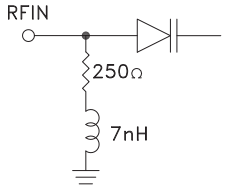
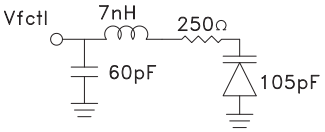
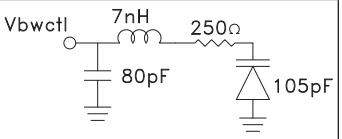
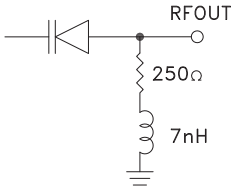
NOTES:
1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
4. Pin BURR LENGTH SHALL BE 0.15mm MAXIMUM. Pin BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

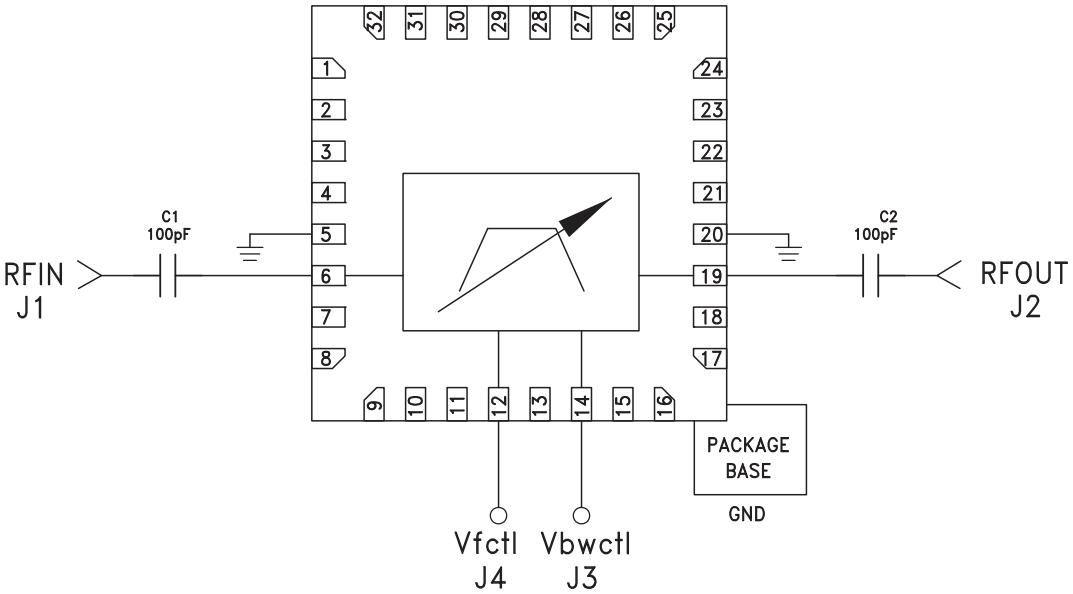
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [1]
HMC890LP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H890 XXXX

[1] 4-Digit lot number XXXX
[2] Max peak reflow temperature of 260 °C

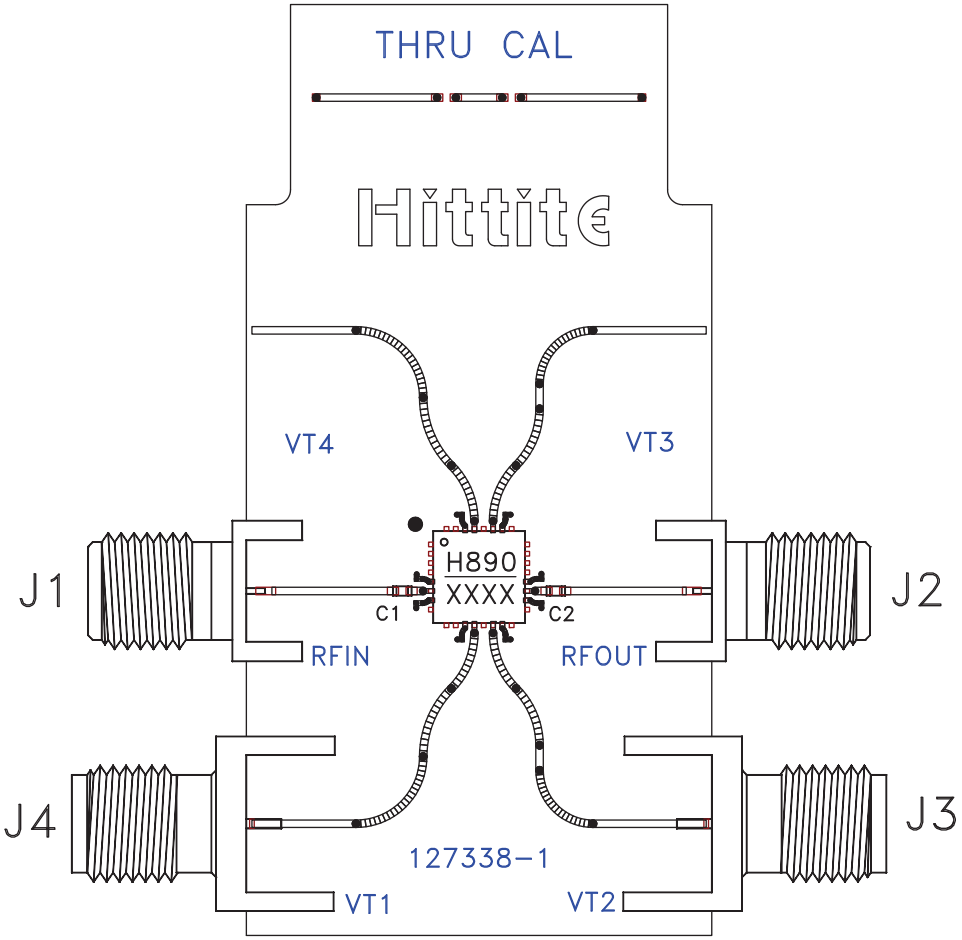
Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1 - 4, 7 - 11, 13 15 - 18, 21 - 32	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
5, 20	GND	These pins and exposed paddle must be connected to RF/DC ground.	
6	RFIN	This pin is DC coupled and matched to 50 Ohms. External voltage must not be applied to this pin.	
12	Vfctl	Center frequency control voltage.	
14	Vbwctl	Bandwidth control voltage.	
19	RFOUT	This pin is DC coupled and matched to 50 Ohms. External voltage must not be applied to this pin.	

Application Circuit



Evaluation PCB



List of Materials for Evaluation PCB 128531 [1]

Item	Description
J1 - J4	SMA - SRI
C1, C2	100 pF Capacitor, 0402 Pkg.
U1	HMC890LP5E Filter
PCB [2]	127338 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25FR or Rogers 25FR

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohms impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.